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 Wumo Pan; Jianming Jin; Guangshun Shi; Wang, Q.R.;  
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**optimization of the curing conditions**  
 Lee, K.K.; Ng, K.T.; Tan, C.W.; Chan, Y.C.; Cheng, L.M.;  
[Business of Electronic Product Reliability and Liability, 2004 International Conf](#)  
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- ☐ 3. **Fabrication of smart card using UV curable anisotropic conductive adhes**  
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